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TC 1700

#4/A 11/21/03

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of)
)
Bravek, et al.)
)
Serial Number: 09/917,483)
)
Filed: 07/27/2001)
)
For: Circuit Board Having)
Improved Soldering)
Characteristics)

Examiner Edmondson

Group Art Unit 1725

AMENDMENT

Commissioner for Patents
Washington, D.C. 20231

AMENDMENT

This Amendment is in response to the Office Action mailed August 09, 2002. Please amend the above referenced patent application as follows.

Charge or credit any large business entity fees to Deposit Account 10-0230.

In the Specification

Page 1, paragraph [0001], line 3, in the heading, delete "CO-PENDING" and insert in its place --RELATED--.

Page 3, paragraph [0005], line 31, delete "station" and insert in its place --stations--.

Substitute paragraphs [0001] and [0005] are attached, together with marked-up copies.

CERTIFICATE OF MAILING

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SIGNATURE

1-9-03

DATE OF SIGNATURE

01/17/2003 SDIRETA1 00000034 09917483
01 FC:1232
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\$10.00 DP
\$4.00 DP

01/17/2003 SDIRETA1 00000032 09917483

02 FC:2201

84.00 DP

Void date: 01/17/2003 SDIRETA1
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